

TS556

Low-power dual CMOS timer

Features

- Very low power consumption: 220 µA typ at V_{CC} = 5 V 180 µA typ at V_{CC} = 3 V
- High maximum astable frequency 2.7 MHz
- Pin-to-pin and functionally compatible with bipolar NE556
- Wide voltage range: 2 V to 16 V
- Supply current spikes reduced during output transitions
- High input impedance: $10^{12} \Omega$
- Output compatible with TTL, CMOS and logic MOS

Description

The TS556 is a dual CMOS timer which offers a very low consumption: ($I_{cc(TYP)}$ TS556 = 220 µA at V_{CC} = +5 V versus $I_{cc(TYP)}$ NE556 = 6 mA), and high frequency: ($f_{(max.)}$ TS556 = 2.7 MHz versus $f_{(max.)}$ NE556 = 0.1 MHz).

In both monostable and astable modes, timing remains very accurate.

The TS556 provides reduced supply current spikes during output transitions, which enable the use of lower decoupling capacitors compared to those required by bipolar NE556.

Due to the high input impedance $(10^{12}\Omega)$, timing capacitors can also be minimized.



1 Absolute maximum ratings and operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	+18	V
I _{OUT}	Output current	± 100	mA
R _{thja}	Thermal resistance junction to ambient DIP14 ⁽¹⁾ SO14 ⁽²⁾	80 105	°C/W
R _{thjc}	Thermal resistance junction to case $DIP14^{(1)}$ $SO14^{(2)}$	33 31	°C/W
Тj	Junction Temperature	+150	°C
T _{stg}	Storage Temperature Range	-65 to +150	°C
	Human body model (HBM) ⁽³⁾	1200	
ESD	Machine model (MM) ⁽⁴⁾	200	V
	Charged device model (CDM) ⁽⁵⁾	1000	

Table 1.Absolute maximum ratings

1. Short-circuits can cause excessive heating. These values are typical and specified for a single layer PCB.

- 2. Short-circuits can cause excessive heating. These values are typical and specified for a four layers PCB.
- Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 4. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins remain floating.
- Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	2 to 16	V
I _{OUT}	Output sink current Output source current	10 50	mA
T _{oper}	Operating free air temperature range: TS556C TS556I TS556M	0 to +70 -40 to +125 -55 to +125	°C



2 Schematic diagram



Figure 1. Schematic diagram (1/2 TS556)



Figure 2. Block diagram



Table 3. Functions table

Reset	Trigger	Threshold	Output
Low	х	х	Low
High	Low	х	High
High	High	High	Low
High	High	Low	Previous State

Note:

LOW: level voltage \leq minimum voltage specified HIGH: level voltage \geq maximum voltage specified x: irrelevant.

3 Electrical characteristics

 Table 4.
 Static electrical characteristics

$V_{CC} = +2 V_1 T_{amb} = +25$	°C, Reset to V	V _{CC} (unless	otherwise specified)
	-,		

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		130	400 400	μA
V _{CL}	Control voltage level T _{min.} ≤T _{amb} ≤T _{max}	1.2 1.1	1.3	1.4 1.5	V
V _{DIS}	Discharge saturation voltage (I _{dis} = 1 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.05	0.2 0.25	V
I _{DIS}	Discharge pin leakage current		1	100	nA
V _{OL}	Low level output voltage (I _{sink} = 1 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.1	0.3 0.35	V
V _{OH}	High level output voltage (I _{source} = -0.3 mA) T _{min.} ≤T _{amb} ≤T _{max}	1.5 1.5	1.9		V
V _{TRIG}	Trigger voltage T _{min.} ≤T _{amb} ≤T _{max}	0.4 0.3	0.67	0.95 1.05	V
I _{TRIG}	Trigger current		10		pА
I _{TH}	Threshold current		10		pА
V _{RESET}	Reset voltage T _{min.} ≤T _{amb} ≤T _{max}	0.4 0.3	1.1	1.5 2.0	V
IRESET	Reset current		10		pА



Symbol	Parameter	Min.	Тур.	Max.	Unit	
I _{CC}	Supply current (no load, high and low states) T _{min} ≤T _{amb} ≤T _{max}		180	460 460	μA	
V _{CL}	Control voltage level T _{min} ≤T _{amb} ≤T _{max}	1.8 1.7	2	2.2 2.3	V	
V_{DIS}	Discharge saturation voltage (I _{dis} = 1 mA) T _{min} ≤T _{amb} ≤T _{max}		0.05	0.2 0.25	V	
I _{DIS}	Discharge pin leakage current		1	100	nA	
V _{OL}	Low level output voltage (I _{sink} = 1 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.1	0.3 0.35	V	
V _{OH}	High level output voltage (I _{source} = -0.3 mA) T _{min.} ≤T _{amb} ≤T _{max}	2.5 2.5	2.9		V	
V _{TRIG}	Trigger voltage T _{min.} ≤T _{amb} ≤T _{max}	0.9 0.8	1	1.1 1.2	V	
I _{TRIG}	Trigger current		10		pА	
I _{TH}	Threshold current		10		pА	
V _{RESET}	Reset voltage T _{min.} ≤T _{amb} ≤T _{max}	0.4 0.3	1.1	1.5 2.0	V	
IRESET	Reset current		10		pА	

 Table 5.
 Static electrical characteristics

 V_{CC} = +3 V, T_{amb} = +25 °C, Reset to V_{CC} (unless otherwise specified)

	$v_{CC} = +5 v$, $r_{amb} = +25 c$, hesel to v_{CC}	(unicess	otherwis	se speci	ieu)
Symbol	Parameter	Min.	Тур.	Max.	Unit
	Timing accuracy (monostable) ⁽¹⁾ R = 10 kΩ C = 0.1 μ F V _{CC} =+2 V, V _{CC} = +3 V		1		%
	Timing shift with supply voltage variations (Monostable) $^{(1)}$ R = 10 kΩ C = 0.1 µF, V _{CC} = +3 V ±0.3 V		0.5		%/V
	Timing shift with temperature ⁽¹⁾ $T_{min.} \leq T_{amb} \leq T_{max}$		75		ppm/°C
f _{max}	Maximum astable frequency $^{(2)}$ R _A = 470 Ω R _B = 200 Ω C = 200 pF		2		MHz
	Astable frequency accuracy $^{(2)}$ R_{A} = R_{B} = 1 $k\Omega$ to 100 $k\Omega$ C = 0.1 μF		5		%
	Timing shift with supply voltage variations (astable mode) $^{(2)}$ B ₄ = B ₅ = 10 kO C = 0.1 µE V _{CC} = +3 to +5 V		0.5		%/V
^t R	Output rise time ($C_{load} = 10 \text{ pF}$)		25		ns
tF	Output fall time (C _{load} = 10 pF)		20	-	ns
t _{PD}	Trigger propagation delay		100		ns
^t RPW	Minimum reset pulse width ($V_{trig} = +3 V$)		350		ns

Table 6.

Dynamic electrical characteristics $V_{CC} = +3 V$, $T_{amb} = +25 °C$, Reset to V_{CC} (unless otherwise specified)

1. See Figure 4.

2. See Figure 6.



Symbol	Parameter	Min.	Тур.	Max.	Unit	
I _{CC}	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		220	500 500	μA	
V _{CL}	Control voltage level T _{min.} ≤T _{amb} ≤T _{max}	2.9 2.8	3.3	3.8 3.9	V	
V_{DIS}	Discharge saturation voltage (I _{dis} = 10 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.2	0.3 0.35	V	
I _{DIS}	Discharge pin leakage current		1	100	nA	
V _{OL}	Low level output voltage (I _{sink} = 8 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.3	0.6 0.8	V	
V _{OH}	High level output voltage (I _{source} = -2 mA) T _{min.} ≤T _{amb} ≤T _{max}	4.4 4.4	4.6		V	
V _{TRIG}	Trigger voltage T _{min.} ≤T _{amb} ≤T _{max}	1.36 1.26	1.67	1.96 2.06	V	
I _{TRIG}	Trigger current		10		pА	
I _{TH}	Threshold current		10		pА	
V _{RESET}	Reset voltage T _{min.} ≤T _{amb} ≤T _{max}	0.4 0.3	1.1	1.5 2.0	V	
IRESET	Reset current		10		pA	

Table 7. Static electrical characteristics $V_{CC} = +5 V$. T_{amb} = +25 °C. Reset to V_{CC} (unless otherwise specified)





Parameter	Min.	Тур.	Max.	Unit
Timing accuracy (monostable) $^{(1)}$ R = 10 k Ω C = 0.1 μ F		2		%
Timing shift with supply voltage variations (monostable) ⁽¹⁾ R = 10 k Ω C = 0.1 μ F, V _{CC} = +5 V ±1 V		0.38		%/V
Timing shift with temperature ⁽¹⁾ T _{min.} ≤T _{amb} ≤T _{max}		75		ppm/°C
Maximum Astable Frequency $^{(2)}$ R _A = 470 Ω R _B = 200 Ω C = 200 pF		2.7		MHz
Astable Frequency Accuracy ⁽²⁾ $R_A = R_B = 1 \text{ k}\Omega \text{ to } 100 \text{ k}\Omega \text{ C} = 0.1 \mu\text{F}$		3		%
Timing shift with supply voltage variations (astable mode) $^{(2)}$ R _A = R _B = 1 kΩ to 100 kΩ C = 0.1 µF, V _{CC} = +5 to +12 V		0.1		%/V
Output rise time (C _{load} = 10 pF)		25		ns
Output fall time (C _{load} = 10 pF)		20	-	ns
Trigger propagation delay		100		ns
Minimum reset pulse width ($V_{trig} = +5 V$)		350		ns
	ParameterTiming accuracy (monostable) (1)R = 10 kQ C = 0.1 μ FTiming shift with supply voltage variations (monostable) (1)R = 10 kQ C = 0.1 μ F, V _{CC} = +5 V ±1 VTiming shift with temperature (1)T _{min.} \leq T _{amb} \leq T _{max} Maximum Astable Frequency (2)R _A = 470 Ω R _B = 200 Ω C = 200 pFAstable Frequency Accuracy (2)R _A = R _B = 1 k Ω to 100 k Ω C = 0.1 μ FTiming shift with supply voltage variations (astable mode) (2)R _A = R _B = 1 k Ω to 100 k Ω C = 0.1 μ F,V _{CC} = +5 to +12 VOutput rise time (C _{load} = 10 pF)Output fall time (C _{load} = 10 pF)Trigger propagation delayMinimum reset pulse width (V _{trig} = +5 V)	ParameterMin.Timing accuracy (monostable) $^{(1)}$ R = 10 kQ C = 0.1 µFTiming shift with supply voltage variations (monostable) $^{(1)}$ R = 10 kQ C = 0.1 µF, V _{CC} = +5 V ±1 VTiming shift with temperature $^{(1)}$ Timing shift with temperature $^{(1)}$ T _{min.} \leq T _{amb} \leq T _{max} Maximum Astable Frequency $^{(2)}$ R _A = 470 Q R _B = 200 Q C = 200 pFAstable Frequency Accuracy $^{(2)}$ R _A = R _B = 1 k Ω to 100 k Ω C = 0.1 µFTiming shift with supply voltage variations (astable mode) $^{(2)}$ R _A = R _B = 1 k Ω to 100 k Ω C = 0.1 µF, V _{CC} = +5 to +12 VOutput rise time (C _{load} = 10 pF)Output fall time (C _{load} = 10 pF)Trigger propagation delayMinimum reset pulse width (V _{trig} = +5 V)Image data for the super	ParameterMin.Typ.Timing accuracy (monostable) $^{(1)}$ 2R = 10 kQ C = 0.1 µF2Timing shift with supply voltage variations (monostable) $^{(1)}$ 0.38R = 10 kQ C = 0.1 µF, $V_{CC} = +5 V \pm 1 V$ 0.38Timing shift with temperature $^{(1)}$ 75Maximum Astable Frequency $^{(2)}$ 2.7Astable Frequency Accuracy $^{(2)}$ 2.7Astable Frequency Accuracy $^{(2)}$ 3Timing shift with supply voltage variations (astable mode) $^{(2)}$ 0.1 $R_A = R_B = 1 k\Omega$ to 100 kQ C = 0.1 µF0.1 $V_{CC} = +5 to + 12 V$ 0.1Output rise time ($C_{load} = 10 \text{ pF}$)25Output fall time ($C_{load} = 10 \text{ pF}$)20Trigger propagation delay100Minimum reset pulse width ($V_{trig} = +5 V$)350	ParameterMin.Typ.Max.Timing accuracy (monostable) ⁽¹⁾ R = 10 kQ C = 0.1 μ F2Timing shift with supply voltage variations (monostable) ⁽¹⁾ R = 10 kQ C = 0.1 μ F, V _{CC} = +5 V ±1 V0.38Timing shift with temperature ⁽¹⁾ T _{min.} $\leq T_{amb} \leq T_{max}$ 75Maximum Astable Frequency ⁽²⁾ R _A = 470 Q R _B = 200 Q C = 200 pF2.7Astable Frequency Accuracy ⁽²⁾ R _A = R _B = 1 k\Omega to 100 kQ C = 0.1 μ F3Timing shift with supply voltage variations (astable mode) ⁽²⁾ 0.1R _A = R _B = 1 k\Omega to 100 kQ C = 0.1 μ F, V _{CC} = +5 to +12 V0.1Output rise time (C _{load} = 10 pF)20Output fall time (C _{load} = 10 pF)20Trigger propagation delay100Minimum reset pulse width (V _{trig} = +5 V)350

Dynamic electrical characteristics $V_{CC} = +5 V$, $T_{amb} = +25 °C$, Reset to V_{CC} (unless otherwise specified) Table 8.

1. See Figure 4.

2. See Figure 6.



Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply current (no load, high and low states) $T_{min.} \leq T_{amb} \leq T_{max}$		340	800 800	μA
V _{CL}	Control voltage level T _{min.} ≤T _{amb} ≤T _{max}	7.4 7.3	8	8.6 8.7	V
V_{DIS}	Discharge saturation voltage (I _{dis} = 80 mA) T _{min.} ≤T _{amb} ≤T _{max}		0.09	1.6 2.0	V
I _{DIS}	Discharge pin leakage current		1	100	nA
V _{OL}	Low level output voltage (I _{sink} = 50 mA) T _{min.} ≤T _{amb} ≤T _{max}		1.2	2 2.8	V
V _{OH}	High level output voltage (I _{source} = -10 mA) T _{min.} ≤T _{amb} ≤T _{max}	10.5 10.5	11		V
V _{TRIG}	Trigger voltage T _{min.} ≤T _{amb} ≤T _{max}	3.2 3.1	4	4.8 4.9	V
I _{TRIG}	Trigger current		10		pА
I _{TH}	Threshold current		10		pА
V _{RESET}	Reset voltage T _{min.} ≤T _{amb} ≤T _{max}	0.4 0.3	1.1	1.5 2.0	V
I _{RESET}	Reset current		10		pА

 Table 9.
 Static electrical characteristics



Table 10. Dynamic electrical characteristics 10.11 10.11

V_{CC} = +12 V, T_{amb} = +25 °C, Reset to V_{CC} (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
	Timing accuracy (monostable) $^{(1)}$ R = 10 kΩ C = 0.1 µF		4		%
	Timing shift with supply voltage variations (monostable) R = 10 k Ω C = 0.1 μ F, V _{CC} = +5 V ±1 V		0.38		%/V
	Timing shift with temperature $T_{min.} \leq T_{amb} \leq T_{max.,} V_{CC} = +5 V$		75		ppm/°C
f _{max}	Maximum astable frequency R_A = 470 Ω R_B = 200 Ω C = 200 pF, V_{CC} = +5 V		2.7		MHz
	Astable frequency accuracy ⁽²⁾ $R_A = R_B = 1 k\Omega$ to 100 k Ω C = 0.1 μ F		3		%
	Timing shift with supply voltage variations (astable mode) $R_A = R_B = 1 \text{ k}\Omega \text{ to } 100 \text{ k}\Omega \text{ C} = 0.1 \mu\text{F},$ $V_{CC} = 5 \text{ to } +12 \text{ V}$		0.1		%/V

1. See Figure 4.

2. See Figure 6.



Figure 3. Supply current (per timer) versus supply voltage



4 Application information

4.1 Monostable operation

In the monostable mode, the timer operates like a one-shot generator. Referring to figure 2, the external capacitor is initially held discharged by a transistor inside the timer, as shown in *Figure 4*.





The circuit triggers on a negative-going input signal when the level reaches $1/3 V_{CC}$. Once triggered, the circuit remains in this state until the set time has elapsed, even if it is triggered again during this interval. The duration of the output HIGH state is given by t = 1.1 R x C.

It can be noticed that since the charge rate and the threshold level of the comparator are both directly proportional to the supply voltage, the timing interval is independent of the supply. Applying a negative pulse simultaneously to the Reset terminal (pin 4) and the Trigger terminal (pin 2) during the timing cycle discharges the external capacitor and causes the cycle to start over. The timing cycle now starts on the positive edge of the reset pulse. While the reset pulse is applied, the output is driven to the LOW state.

When a negative trigger pulse is applied to pin 2, the flip-flop is set, releasing the short circuit across the external capacitor and driving the output HIGH. The voltage across the capacitor increases exponentially with the time constant $\tau = R \times C$.

When the voltage across the capacitor equals $2/3 V_{CC}$, the comparator resets the flip-flop which then discharges the capacitor rapidly and drives the output to its LOW state. *Figure 5* shows the actual waveforms generated in this mode of operation.

When Reset is not used, it should be tied high to avoid any possible or false triggering.





4.2 Astable operation

When the circuit is connected as shown in *Figure 6* (pins 2 and 6 connected) it triggers itself and runs as a multivibrator. The external capacitor charges through R_A and R_B and discharges through R_B only. Thus the duty cycle may be precisely set by the ratio of these two resistors.

In the astable mode of operation, C charges and discharges between 1/3 V_{CC} and 2/3 V_{CC}. As in the triggered mode, the charge and discharge times and therefore frequency, are independent of the supply voltage.

Figure 6. Application schematic



Figure 7 shows actual waveforms generated in this mode of operation.

The charge time (output HIGH) is given by:

$$t1 = 0.693 (R_A + R_B) C$$

and the discharge time (output LOW) by:

 $t2 = 0.693 x R_B x C$

Thus the total period T is given by:

 $T = t1 + t2 = 0.693 (R_A + 2R_B) C$

The frequency of oscillation is then:

$$f = \frac{1}{T} = \frac{1.44}{(RA + 2RB)C}$$

The duty cycle is given by:

$$\mathsf{D} = \frac{\mathsf{R}\mathsf{B}}{\mathsf{R}\mathsf{A} + 2\mathsf{R}\mathsf{B}}$$

Figure 7. Timing diagram



57

5 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: <u>www.st.com</u>.



5.1 DIP14 package information

Figure 8. DIP14 package mechanical drawing



Table 11. DIP14 package mechanical data

Dimensions						
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			5.33			0.21
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.11	0.13	0.19
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.04	0.06	0.07
с	0.20	0.25	0.36	0.007	0.009	0.01
D	18.67	19.05	19.69	0.73	0.75	0.77
E	7.62	7.87	8.26	0.30	0.31	0.32
E1	6.10	6.35	7.11	0.24	0.25	0.28
е		2.54			0.10	
e1		15.24			0.60	
eA		7.62			0.30	
eB			10.92			0.43
L	2.92	3.30	3.81	0.11	0.13	0.15

Note:

D and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm.

57

5.2 SO-14 package information





Table 12. SO-14 package mechanical data

Dimensions						
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	1.35		1.75	0.05		0.068
A1	0.10		0.25	0.004		0.009
A2	1.10		1.65	0.04		0.06
В	0.33		0.51	0.01		0.02
С	0.19		0.25	0.007		0.009
D	8.55		8.75	0.33		0.34
E	3.80		4.0	0.15		0.15
е		1.27			0.05	
Н	5.80		6.20	0.22		0.24
h	0.25		0.50	0.009		0.02
L	0.40		1.27	0.015		0.05
k	8° (max.)					
ddd			0.10			0.004

Note:

D and F dimensions do not include mold flash or protrusions. Mold flash or protrusions must not exceed 0.15 mm.

16/19	

57

6 Ordering information

Order code	Temperature range	Package	Packaging	Marking
TS556CN		DIP14	Tube	TS556CN
TS556CD TS556CDT	0°C, +70°C	SO-14	Tube or Tape & reel	556C
TS556IN		DIP14	Tube	TS556IN
TS556ID TS556IDT	-40°C, +125°C	SO-14	Tube or Tape & reel	5561
TS556MN		DIP14	Tube	TS556MN
TS556MD TS556MDT	-55°C, +125°C	SO-14	Tube or Tape & reel	556M

Table 13. Order codes



7 Revision history

Table 14.	Document revision history
-----------	---------------------------

Date	Revision	Changes
01-Feb-2003	1	Initial release.
28-Oct-2008	2	Document reformatted. Added output current, ESD and thermal resistance values in <i>Table 1: Absolute maximum ratings.</i> Added output current values in <i>Table 2: Operating conditions.</i> Updated Section 5.1: DIP14 package information and Section 5.2: SO-14 package information.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2008 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



19/19